

10 SEGMENT BAR GRAPH ARRAY

Part Number: DC7G3HWA

Green Bright Red

Features

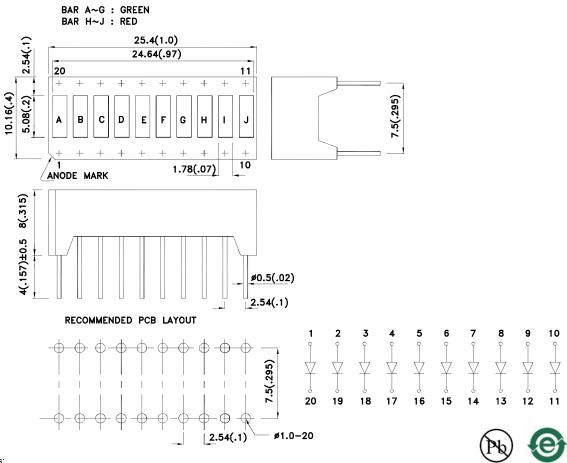
- Suitable for level indicators.
- Low current operation.
- Excellent on/off contrast.
- End stackable.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

The Bright Red source color devices are made with Gallium Phosphide Red Light Emitting Diode.

Package Dimensions & Internal Circuit Diagram



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: J.Yu
 ERP: 1331000171

Selection Guide

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description	
			Min.	Тур.	•	
DC7G3HWA	Green (GaP)	White Diffused	5600	12000	10 Segments Bar graph-Display	
	Bright Red (GaP)		900	1900	7xGreen 3xBright Red	

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green Bright Red	565 700		nm	I==20mA
λD [1]	Dominant Wavelength	Green Bright Red	568 660		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Green Bright Red	30 45		nm	I=20mA
С	Capacitance	Green Bright Red	15 40		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green Bright Red	2.2 2.25	2.5 2.5	V	I==20mA
lR	Reverse Current	Green Bright Red		10	uA	VR=5V

Notes:

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Bright Red	Units		
Power dissipation	62.5	62.5	mW		
DC Forward Current	25	25	mA		
Peak Forward Current [1]	140	130	mA		
Reverse Voltage	Į.	V			
Operating/Storage Temperature	-40°C To +85°C				
Lead Solder Temperature [2]	260°C For 3-5 Seconds				

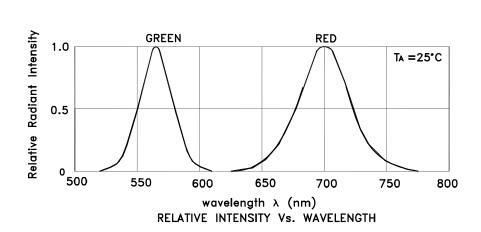
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.

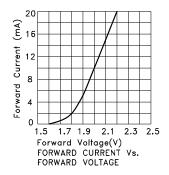
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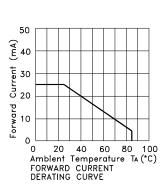
Note:
1. Luminous intensity/ luminous Flux: +/-15%.

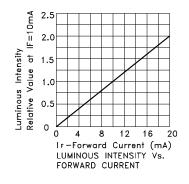
^{1.}Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

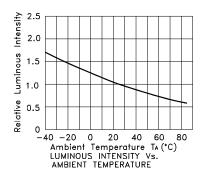


DC7G3HWA Green









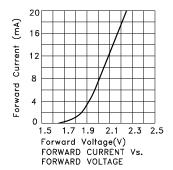
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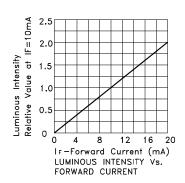
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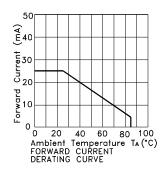
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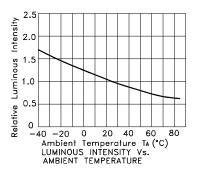
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Bright Red

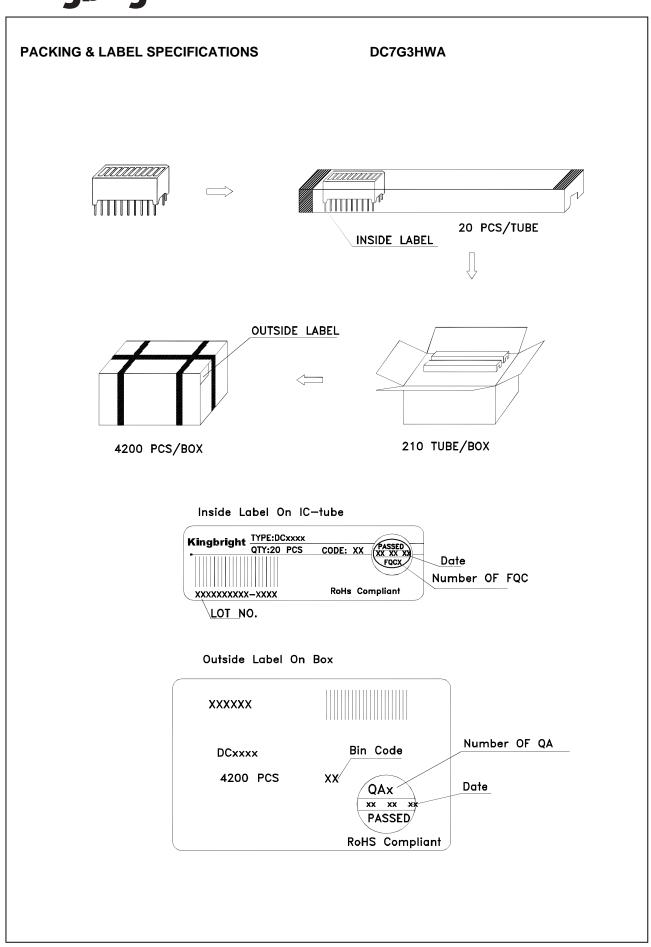








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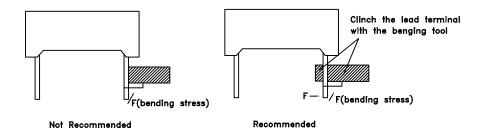


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THROUGH HOLE DISPLAY MOUNTING METHOD

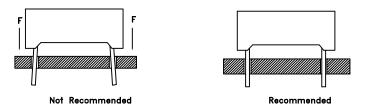
Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



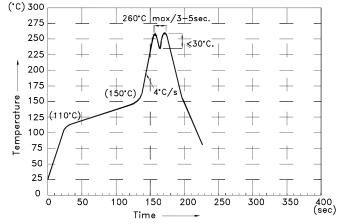
Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
- 5.No more than once.

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Soldering General Notes:

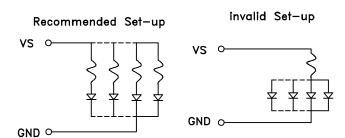
- a. Through—hole displays are incompatible with reflow soldering.
- b. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



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